

Maximizing IC Performance

## DESCRIPTION

The MT7832A is a high-PF, non-isolate LED Driver IC. The floating-ground, high-side BUCK topology makes full wave detection possible. The MT7832A works in Quasi-Resonant mode (QRM), which improves both of efficiency and EMI performance. Selectable maximum period control is integrated, such that flick can be eliminated while enough demagnetization time is guaranteed.

Various protections such as OVP, OCP, OTP, etc, are embedded to improve reliability. The MT7832A integrate 550V MOSFET internally, which simplifies external circuit.

The driving capability of the MT7832A is designed to be insensitive to VDD voltage and soft, with MAXIC proprietary technique. It can help to improve EMI performance greatly.

# **FEATURES**

- Single-stage active power factor correction (PFC > 0.90)
- High accurate LED current (±3%)
- Good Line and Load Regulation (±2%)
- Quasi-Resonant mode (QRM) operation
- Various protection schemes.
- Power-on soft-start
- Support powered by single-winding inductor
- Compact package: SOP8

#### APPLICATIONS

- E27/PAR30/PAR38/GU10 LED lamp
- T8/T10 LED tube
- Other LED lighting applications







# **ABSOLUTE MAXIMUM RATINGS**

VDD Pin Voltage	-0.3V to VDD Clamp	
Drain Pin Voltage	-0.3V to 550V	
COMP/CS/DSEN Pins Voltage	-0.3V to 6V	
Lead Temperature (soldering, 10 sec.)	260°C	
P <sub>DMAX</sub> (maximum power consumption)	0.8W	
Storage Temperature	-55°C to 150°C	

## **Recommended operating conditions**

Supply voltage	9V to 24V
Operating Temperature (Environment)	-40°C to 105°C
Output Power	≤ 9W @ 90VAC~264VAC
	≤ 13W @ 176VAC~264VAC

## **Thermal resistance**<sup>10</sup>

Junction to ambient (ReJA)	128°C/W
•	

#### Note:

(1) ReJA is measured in the natural convection at  $TA = 25^{\circ}C$  on a low effective single layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard. Test condition: Device mounted on 2" X 2" FR-4 substrate PCB, 2oz copper, with minimum recommended pad on top layer and thermal vias to bottom layer ground plane.

# **PIN CONFIGURATIONS**



#### **PIN DESCRIPTION**

Name	Pin No.	Description
COMP	1	Internal EA's output pin. Connect a capacitor to ground for frequency
		compensation.
DSEN	2	Feedback pin for inductor zero current crossing detection.
VDD	3	Power Supply pin.
CS	4	Source of internal MOSFET, and Current Sense pin.
DRAIN	5,6	Drain of internal MOSFET.
NC	7	No connection pin.
GND	8	Ground pin.